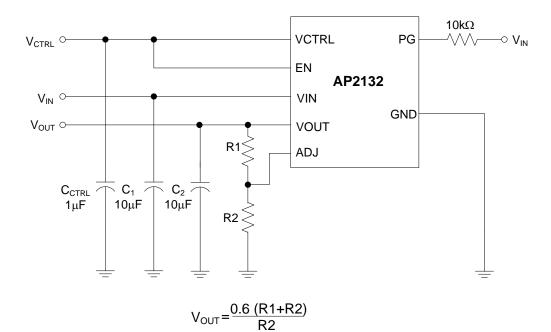
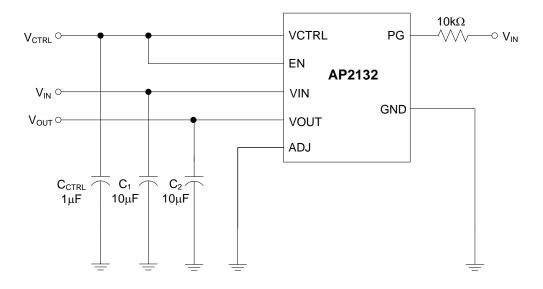


Typical Applications Circuit



Do not program below 0.6V Typical Application of AP2132 for Adjustable Version



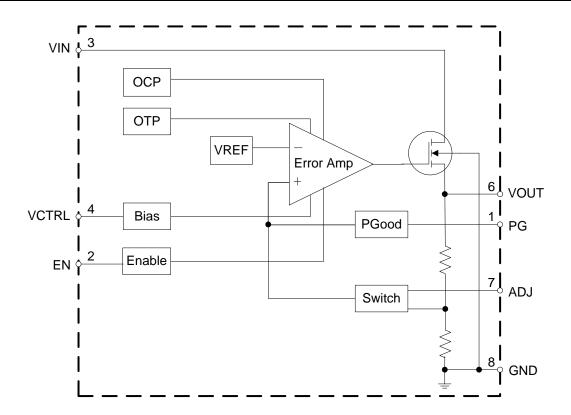
Typical Application of AP2132 for Fixed Version



Pin Description

Pin Number	Pin Name	Function
1	PG	Assert high once V _{OUT} reaches 92% of its rating voltage
2	EN	Enable input
3	VIN	Input voltage
4	VCTRL	Input voltage for controlling circuit
5	NC	Not connected
6	VOUT	Regulated output voltage
7	ADJ	Internal Mode ADJ is connected to ground. The output voltage is set by internal resistors External Mode ADJ is connected to external feedback resistors. The output voltage will be V _{OUT} = 0.6 (R1+R2)/R2. Do not program below 0.6V
8	GND	Ground
Thermal Pad	GND or Open	The pad may be grounded or left open. This does not replace the need for ground on Pin 8.

Functional Block Diagram





Absolute Maximum Ratings (Note 4)

Symbol	Parameter	Rating	Unit
V _{IN} V _{CTRL}	Input Voltage Input Voltage for Controlling Circuit	6.0	V
V_{EN}	Enable Input Voltage	-0.3 to 6.0	V
I _{OUT}	Output Current	2.5	Α
θЈА	Thermal Resistance (No Heatsink)	130	°C/W
TJ	Operating Junction Temperature	+150	°C
T _{STG}	Storage Temperature Range	-65 to +150	°C
T _{LEAD}	Lead Temperature (Soldering, 10sec)	+260	°C
_	ESD (Machine Model)	200	V
_	ESD (Human Body Model)	2000	V

Note 4: Stresses greater than those listed under "Absolute Maximum Ratings" can cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods can affect device reliability.

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
V _{IN}	Input Voltage	1.4	5.5	V
V _{CTRL}	Input Voltage for Controlling Circuit	4.5	5.5	V
TA	Operating Ambient Temperature Range	-40	+85	°C



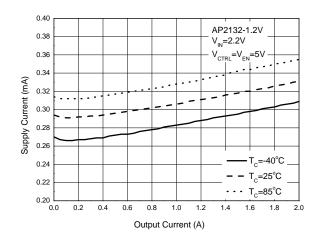
Electrical Characteristics (@V_{IN} = V_{OUT}+0.5V, V_{CTRL} = V_{EN} = 5V, T_A = +25°C, C_{IN} = C_{OUT} = 10 μ F, C_{CTRL} = 1 μ F, I_{OUT} = 10mA, **Bold** typeface applies -40°C \leq T_A \leq +85°C unless otherwise specified.)

Symbol	Parameter Conditi		ns	Min	Тур	Max	Unit
V _{OUT}	Output Voltage	V _{IN} = V _{OUT} +0.5V, I _{OUT} =10mA		V _{ОUТ} х 98%	_	V _{OUT} × 102%	V
V _{IN}	Input Voltage	_		1.4	_	5.5	V
I _{OUT} (max)	Max. Output Current	V _{IN} – V _{OUT} = 1V, V _{OUT} =	98%xV _{OUT}	2	_	_	А
V _{RLOAD}	Load Regulation	V _{IN} = V _{OUT} +0.5V, 10mA	≤ I _{OUT} ≤ 2A	_	10	_	mV
V _{RLINE}	Line Regulation	V _{OUT} + 0.5V ≤ V _{IN} ≤ 5V, I	_{OUT} = 10mA	_	2	_	mV
		I _{OUT} = 500mA		_	80	120	mV
V_{DROP}	Dropout Voltage	I _{OUT} = 1A	_	150	200	mV	
		I _{OUT} = 2A	I _{OUT} = 2A			450	mV
I _{SUPPLY}	Supply Current	V _{IN} = V _{OUT} +0.5V, I _{OUT} = 0	V _{IN} = V _{OUT} +0.5V, I _{OUT} = 0mA		300	_	μA
I _{CTRLH}	WOTEL O	V _{IN} = V _{OUT} +0.5V, V _{CTRL} = V _{EN} = 5V		_	250	500	μA
I _{CTRLL}	VCTRL Current	V _{IN} = V _{OUT} +0.5V, V _{CTRL} = 5V, V _{EN} = 0V		_	0.1	1	μA
		Ripple 0.5Vp-p,	f = 100Hz	_	60	_	dB
PSRR	Power Supply Rejection Ratio	$V_{IN} = V_{OUT} + 1V$ $f = 1kHz$		_	60	_	dB
ΔV _{OUT}	Output Voltage Temperature Coefficient	$I_{OUT} = 10 \text{mA}, -40 ^{\circ}\text{C} \le T_{A} \le +85 ^{\circ}\text{C}$		_	±100	_	ppm/°C
V _{REF}	Reference Voltage	Adjust Short to V _{OUT}		0.588	0.6	0.612	V
_	Enable "High" Voltage	Enable Input Voltage "High"		1.5	_	_	V
_	Enable "Low" Voltage	Enable Input Voltage "Lo	w"	_	_	0.4	V
OTSD	Thermal Shutdown	_		_	+165	_	°C
_	Thermal Shutdown Hysteresis	_		_	+20	_	°C
V _{THPG}	Vout Power Good Voltage	_			92	_	%
_	V _{PG} Hysteresis	_		_	7	_	%
_	Adjust Pin Threshold	_		<u> </u>	200	_	mV
θ _{JC}	Thermal Resistance (Junction to Case)	PSOP-8		_	40	_	°C/W

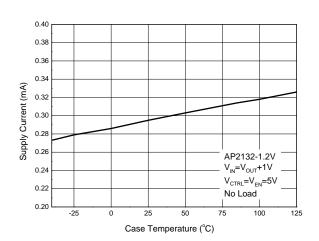


Performance Characteristics

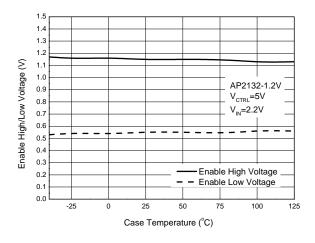
Supply Current vs. Output Current



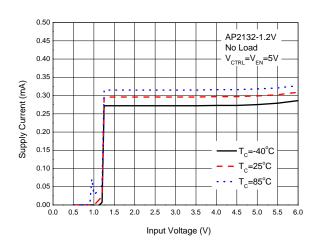
Supply Current vs. Case Temperature



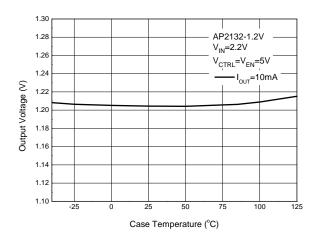
Enable High/Low Voltage vs. Case Temperature



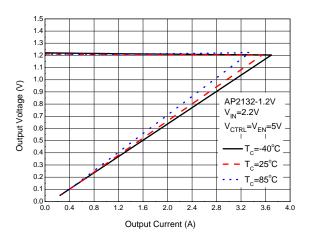
Supply Current vs. Input Voltage



Output Voltage vs. Case Temperature



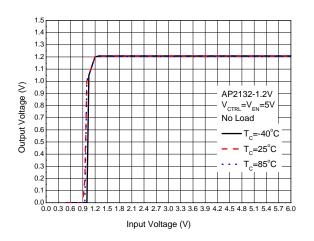
Output Voltage vs. Output Current



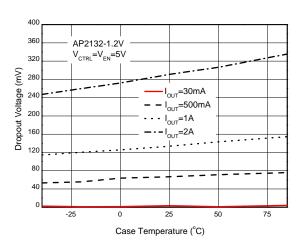


Performance Characteristics (continued)

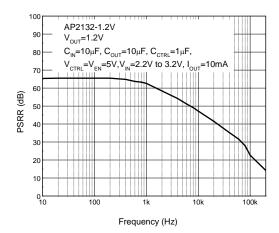
Output Voltage vs. Input Voltage



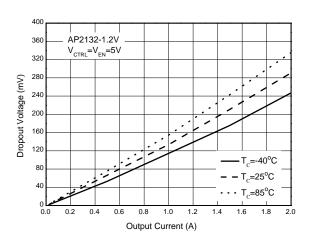
Dropout Voltage vs. Case Temperature



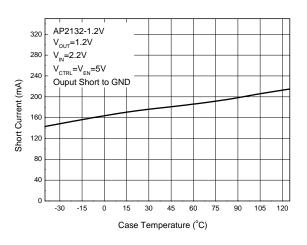
PSRR vs. Frequency



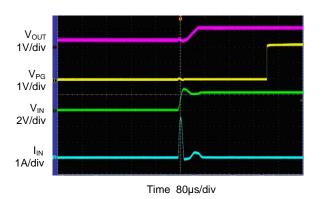
Dropout Voltage vs. Output Current



Short Current vs. Case Temperature



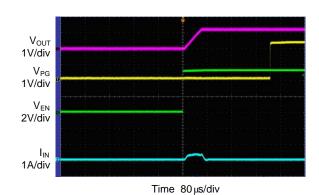
 V_{IN} Start up Waveform ($V_{\text{CTRL}} = V_{\text{EN}} = 5V$, $V_{\text{IN}} = 0$ to 2.2V, No Load)



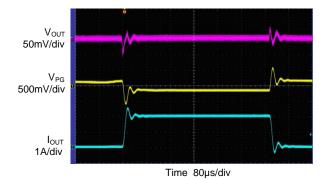


Performance Characteristics (continued)

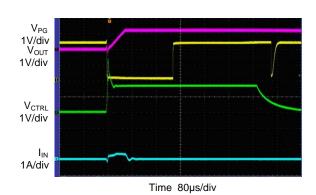
V_{EN} Start up Waveform (V_{CTRL}=5V, V_{EN}=0 to 5V, V_{IN}=2.2V, No Load)



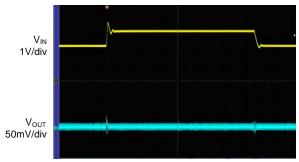
Load Transient (V_{CTRL}=V_{EN}=5V, V_{IN}=2.2V, I_{OUT}=0 to 2A)



 V_{CTRL} Start up and Shut down Waveform (V_{CTRL} =0 to 5V, V_{EN} =5V, V_{IN} =2.2V, No Load)



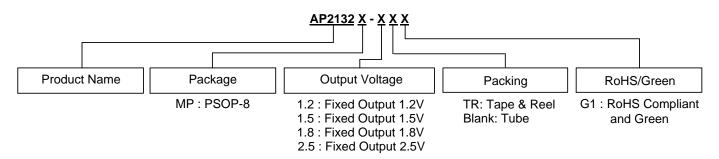
 $\label{eq:continuous} Line Transient $$(V_{CTRL}=V_{EN}=5V,~C_{IN}=C_{CTRL}=1\mu F,~C_{OUT}=10\mu F,~V_{IN}=2.2V~to~3.2V,~I_{OUT}=10mA)$$$



Time 80µs/div



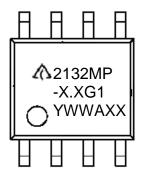
Ordering Information



Package	Temperature Range	Version Description	Part Number	Marking ID	Packing
	-40 to +85°C	Each fixed output version integrates ADJ version	AP2132MP-1.2G1	2132MP-1.2G1	100/Tube
			AP2132MP-1.2TRG1	2132MP-1.2G1	4000/Tape & Reel
			AP2132MP-1.5G1	2132MP-1.5G1	100/Tube
			AP2132MP-1.5TRG1	2132MP-1.5G1	4000/Tape & Reel
PSOP-8			AP2132MP-1.8G1	2132MP-1.8G1	100/Tube
			AP2132MP-1.8TRG1	2132MP-1.8G1	4000/Tape & Reel
			AP2132MP-2.5G1	2132MP-2.5G1	100/Tube
			AP2132MP-2.5TRG1	2132MP-2.5G1	4000/Tape & Reel

Marking Information

(Top View)



First and Second Lines: Logo and Marking ID

(See Ordering Information) Third Line: Date Code

Y: Year

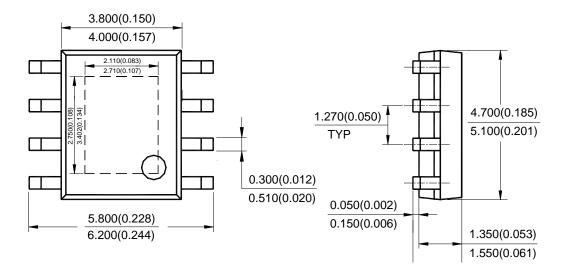
WW: Work Week of Molding

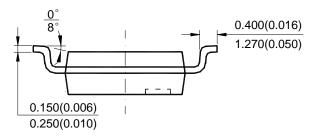
A: Assembly House Code
XX: 7th and 8th Digits of Batch Number



Package Outline Dimensions (All dimensions in mm(inch).)

(1) Package Type: PSOP-8



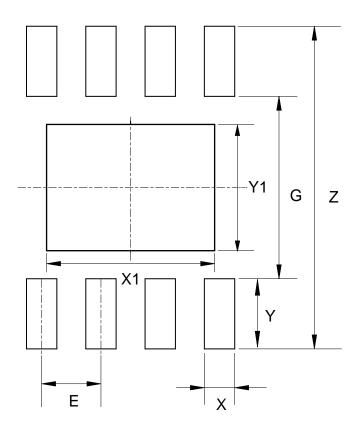


Note: Eject hole, oriented hole and mold mark is optional.



Suggested Pad Layout

(1) Package Type: PSOP-8



Dimensions	Z (mm)/(inch)	G (mm)/(inch)	X (mm)/(inch)	Y (mm)/(inch)	X1 (mm)/(inch)	Y1 (mm)/(inch)	E (mm)/(inch)
Value	6.900/0.272	3.900/0.154	0.650/0.026	1.500/0.059	3.600/0.142	2.700/0.106	1.270/0.050



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